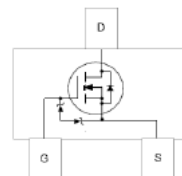
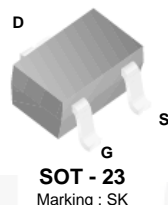


BSS138K

N-Channel Logic Level Enhancement Mode Field Effect Transistor

Features

- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Ultra-Small Surface Mount Package
- Pb Free / RoHS Compliant
- Green Compound
- ESD HBM = 2000 V as per JEDEC A114A; ESD CDM = 2000 V as per JEDEC C101C



Absolute Maximum Ratings⁽¹⁾

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only. Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted.

Symbol	Parameter	Value	Units
V_{DS}	Drain-Source Voltage	50	V
V_{GS}	Gate-Source Voltage	± 12	V
I_D	Drain Current	Continuous	A
		Pulsed	
T_J	Operating Junction Temperature Range	-55 to +150	$^\circ\text{C}$
T_{STG}	Storage Temperature Range	-55 to +150	$^\circ\text{C}$

Note:

1. These ratings are limiting values above which the serviceability of any semiconductor device maybe impaired.

Thermal Characteristics

Symbol	Parameter	Value	Units
P_D	Total Device Dissipation	350	mW
	Derating above $T_A = 25^\circ\text{C}$	2.8	mW/ $^\circ\text{C}$
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient ⁽²⁾	350	$^\circ\text{C/W}$

Note:

2. Device mounted on FR-4 PCB, 1 inch x 0.85 inch x 0.062 inch. Minimum land pad size.

Package Marking and Ordering Information

Device Marking	Device	Reel Size	Tape Width	Quantity
SK	BSS138K	7"	8 mm	3000 units

Electrical Characteristics

Values are at $T_A = 25^\circ\text{C}$ unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
Off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0\text{ V}, I_D = 10\text{ }\mu\text{A}$	50			V
$\frac{BV_{DSS}}{T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250\text{ }\mu\text{A}$, Referenced to 25°C		0.11		V/ $^\circ\text{C}$
I_{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 50\text{ V}, V_{GS} = 0\text{ V}$			0.1	μA
I_{GSS}	Gate-Body Leakage	$V_{GS} = \pm 12\text{ V}, V_{DS} = 0\text{ V}$			± 1	μA
		$V_{GS} = \pm 10\text{ V}, V_{DS} = 0\text{ V}$			± 0.5	
		$V_{GS} = \pm 5\text{ V}, V_{DS} = 0\text{ V}$			± 0.05	
On Characteristics						
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	0.6		1.2	V
$\frac{V_{GS(th)}}{T_J}$	Gate Threshold Voltage Temperature Coefficient	$I_D = 1\text{ mA}$, Referenced to 25°C		-1.4		mV/ $^\circ\text{C}$
$R_{DS(ON)}$	Static Drain-Source On-Resistance	$V_{GS} = 1.8\text{V}, I_D = 50\text{ mA}$,			2.5	Ω
		$V_{GS} = 2.5\text{ V}, I_D = 50\text{ mA}$			2.0	
		$V_{GS} = 5\text{V}, I_D = 50\text{ mA}$			1.6	
$I_{D(ON)}$	On-State Drain Current	$V_{GS} = 10\text{ V}, V_{DS} = 5\text{ V}$	0.2			A
g_{FS}	Forward Transconductance	$V_{DS} = 10\text{ V}, I_D = 200\text{ mA}$	200			mS
Dynamic Characteristics						
C_{iss}	Input Capacitance	$V_{DS} = 25\text{ V}, V_{GS} = 0\text{ V},$ $f = 1.0\text{ MHz}$		58		pF
C_{oss}	Output Capacitance			9.75		
C_{rss}	Reverse Transfer Capacitance			5.2		
R_G	Gate Resistance	$V_{DS} = 5\text{ V}, V_{GS} = 10\text{ mV}$		281		Ω
Switching Characteristics						
$t_{D(ON)}$	Turn-On Delay Time	$V_{DD} = 30\text{ V}, I_D = 0.29\text{ A},$ $V_{GS} = 10\text{ V}, R_{GEN} = 6\text{ }\Omega$			5	ns
t_r	Turn-On Rise Time				5	
$t_{D(OFF)}$	Turn-Off Delay Time				60	
t_f	Turn-Off Fall Time				35	
Q_g	Total Gate Change	$V_{DS} = 25\text{ V}, I_D = 0.2\text{ A},$ $V_{GS} = 10\text{ V}, I_G = 0.1\text{ mA}$			2.4	nC
Q_{gs}	Gate-Source Change				0.5	
Q_{gd}	Gate-Drain Change				0.5	
Drain-Source Diode Characteristics and Maximum Ratings						
V_{sd}	Drain-Source Diode Forward Voltage	$V_{GS} = 0\text{ V}, I_S = 115\text{ mA}$			1.2	V

Typical Performance Characteristics

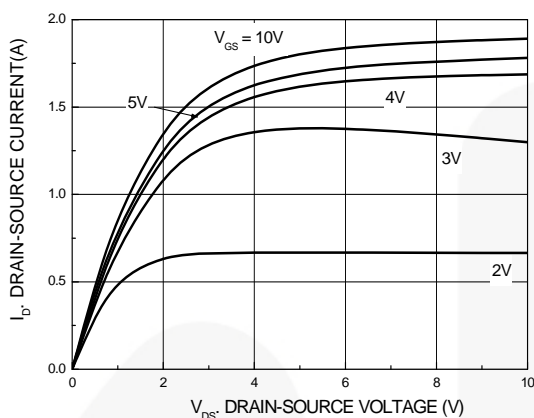


Figure 1. On-Region Characteristics

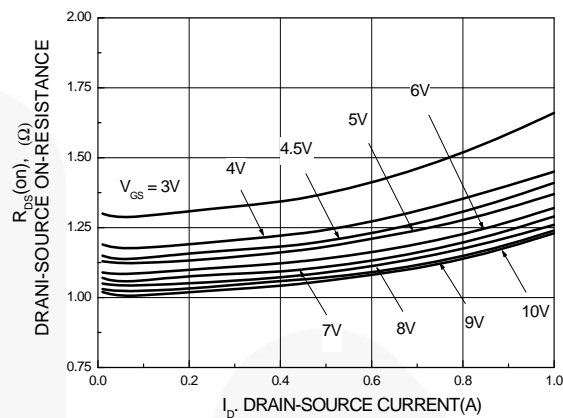


Figure 2. On-Resistance Variation with Gate Voltage and Drain Current

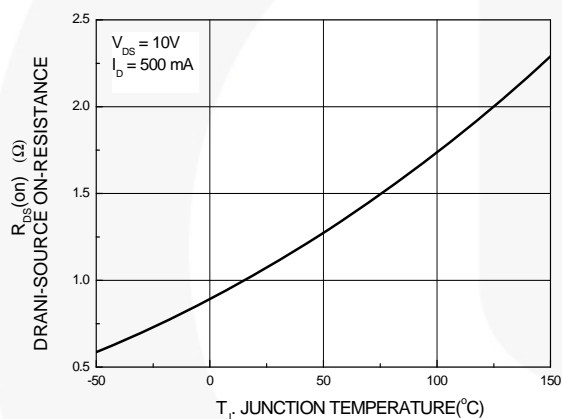


Figure 3. On-Resistance Variation with Temperature

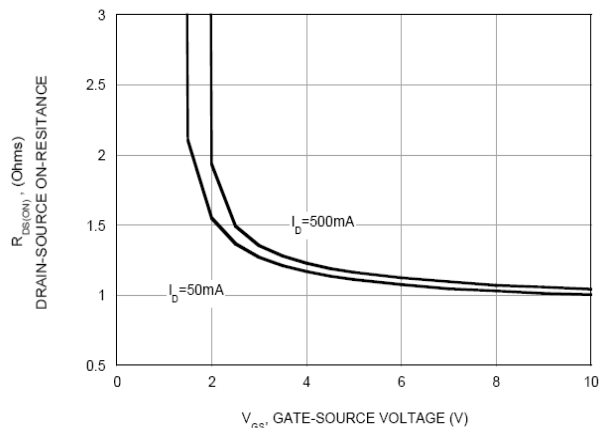


Figure 4. On-Resistance Variation with Gate-Source Voltage

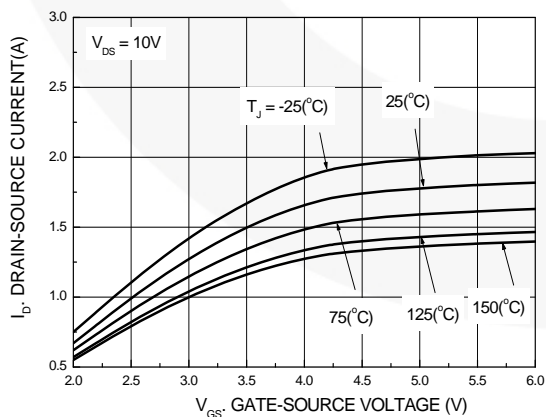


Figure 5. Transfer Characteristics

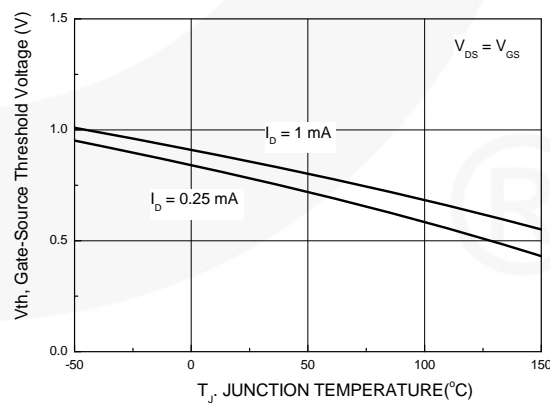


Figure 6. Gate Threshold Variation with Temperature

Typical Performance Characteristics (Continue)

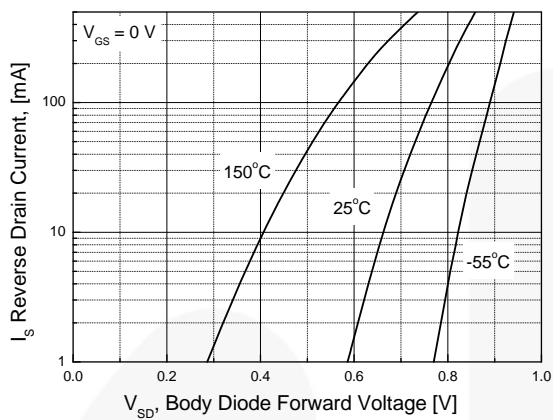


Figure 7. Reverse Drain Current Variation with Diode Forward Voltage and Temperature

Physical Dimensions

SOT-23

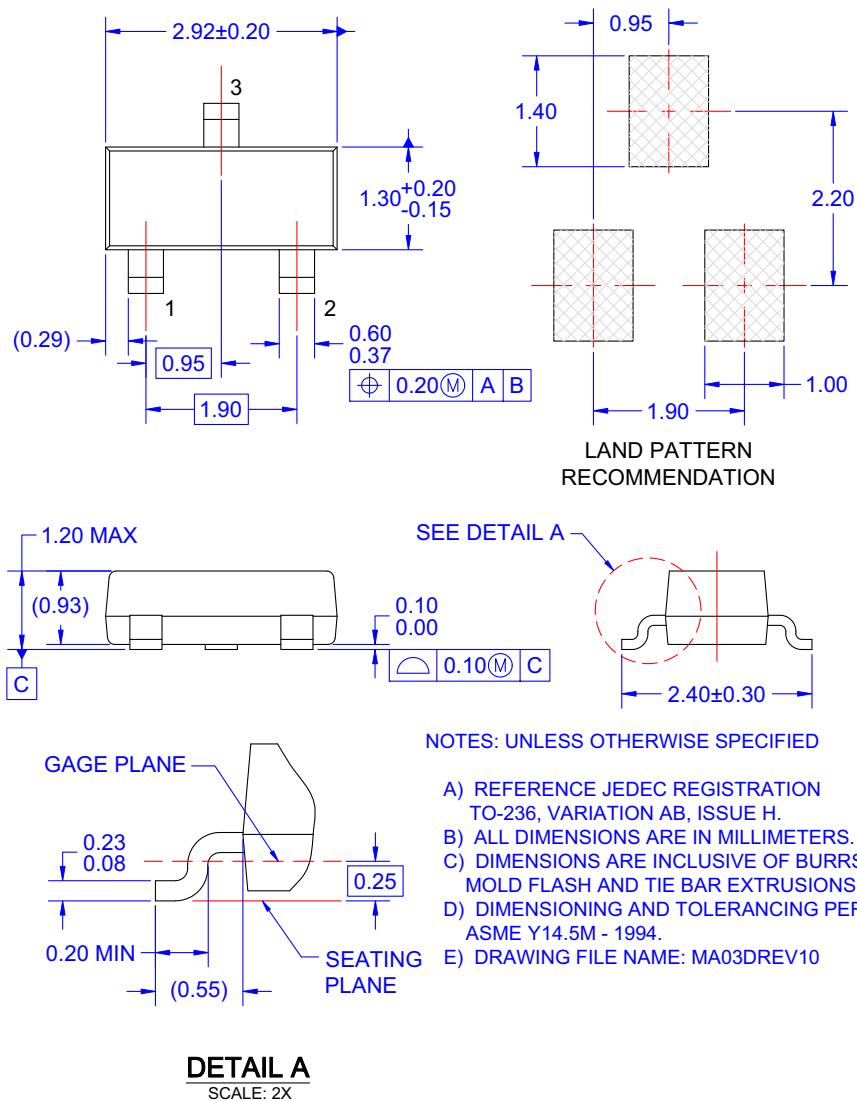


Figure 8. 3LEAD, SOT23, JEDEC TO-236, LOW PROFILE (ACTIVE)

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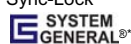



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